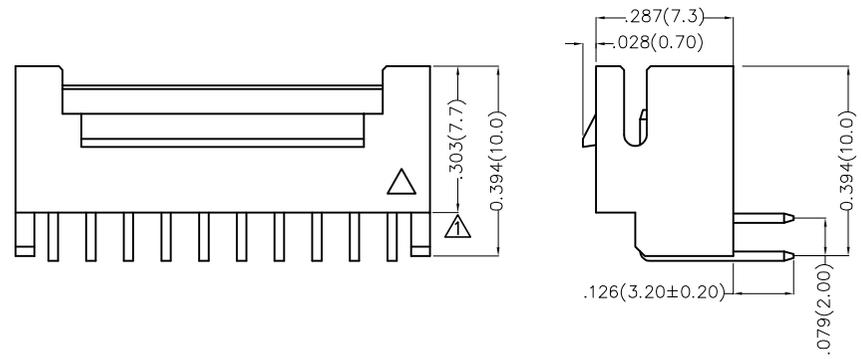
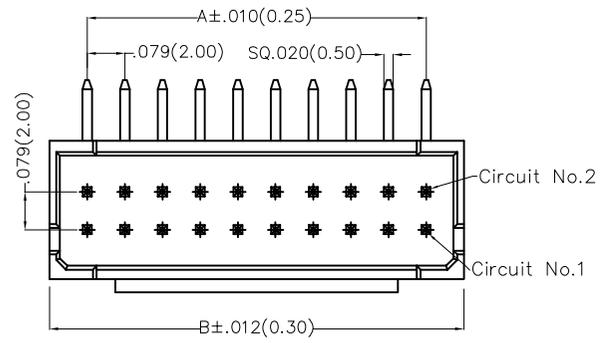


REV	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD
1	△	Size changes	23/DEC/24	MATT	LEO
2	△	Correct the Color-Resin	30/MAR/26	MATT	LEO

Electrical  
 Current Rating: 3.0A AC(rms)/DC  
 Voltage Rating: 250V AC(rms)/DC  
 Contact Resistance: 30 mΩ Max  
 Insulation Resistance: 1000 MΩ MIN  
 Withstanding Voltage: 1000V AC r.m.s  
 Temperature Range-Operating: -25°C~+85°C

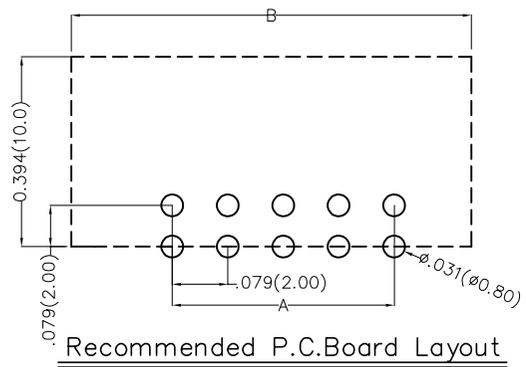
Material and Plating  
 Housing: PA46( UL 94V-0)  
 Contact Pin: Brass  
 Plating: Tin Plated  
 Mates With(Housing): FHG20007 Series



Ordering Information

FWF 200 17 — D XX B 2 2 W5 B  
 1 2 3 4 5 6 7 8 9 10

1   Category FWF-Wafer	2   Series Number 200-Pitch2.0mm	3   Distinction No. 17	4   Row Option Double Row	5   Circuits XX	6   Entry Angle B-90° Angle
7   Plating 2-Tin Plated	8   Material-Resin 2-PA46	9   Color-Resin W5-Natural △	10   Packaging B-PE Bag		



THIRD ANGLE PROJECTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		APPROVE BY FRANK	DATE 18/JUN/13	PART NO. FWF20017-DXXB22W5B	ITEM NO. FWF20017	 Building Technology Cornerstone
	DESIGN UNITS Inch (metric)	X.±.012(0.30) X.X±.010(0.25) X.XX±.006(0.15) X.XXX±.004(0.10)	X:±5' .X'±2' .XX'±1' .XXX'±0.5'	CHECKED BY JACOB	DATE 18/JUN/13	TITLE Wire to Board (Wafer) Pitch 2.0mm 90° Angled (DIP)	
SCALE 5:1	SIZE A4	DRAWN BY CHERRY		DATE 18/JUN/13	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO TXGA INDUSTRIAL ELECTRONICS(S.Z)CO.,LTD AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		

1 2 3 4 5 6 7 8

REV	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD

A

B

C

D

E

F

A

B

C

D

E

F

Circuits (n)	Part No.	Dimensions(in/mm)	
		A	B
4	FWF20017-D04B22W5B	.079(2.00)	.236(6.00)
6	FWF20017-D06B22W5B	.157(4.00)	.315(8.00)
8	FWF20017-D08B22W5B	.236(6.00)	.394(10.00)
10	FWF20017-D10B22W5B	.315(8.00)	.472(12.00)
12	FWF20017-D12B22W5B	.394(10.00)	.551(14.00)
14	FWF20017-D14B22W5B	.472(12.00)	.630(16.00)
16	FWF20017-D16B22W5B	.551(14.00)	.709(18.00)
18	FWF20017-D18B22W5B	.630(16.00)	.787(20.00)
20	FWF20017-D20B22W5B	.709(18.00)	.866(22.00)
22	FWF20017-D22B22W5B	.787(20.00)	.945(24.00)
24	FWF20017-D24B22W5B	.866(22.00)	1.024(26.00)
26	FWF20017-D26B22W5B	.945(24.00)	1.102(28.00)
28	FWF20017-D28B22W5B	1.024(26.00)	1.181(30.00)
30	FWF20017-D30B22W5B	1.102(28.00)	1.260(32.00)
32	FWF20017-D32B22W5B	1.181(30.00)	1.339(34.00)
34	FWF20017-D34B22W5B	1.260(32.00)	1.417(36.00)
36	FWF20017-D36B22W5B	1.339(34.00)	1.496(38.00)
38	FWF20017-D38B22W5B	1.417(36.00)	1.575(40.00)
40	FWF20017-D40B22W5B	1.496(38.00)	1.654(42.00)

 THIRD ANGLE PROJECTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		APPROVE BY FRANK	DATE 18/JUN/13	PART NO. FWF20017-DXXB22W5B	ITEM NO. FWF20017	 Building Technology Cornerstone	
	DESIGN UNITS Inch (metric)	X.±.012(0.30)    X'±5'	CHECKED BY JACOB	DATE 18/JUN/13	TITLE Wire to Board (Wafer) Pitch 2.0mm 90° Angled (DIP)			REV 2    SHEET NO. 2/2
	SCALE 5:1	SIZE A4	X.XX±.006(0.15)    .XX'±1'	DRAWN BY CHERRY	DATE 18/JUN/13	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO TXGA INDUSTRIAL ELECTRONICS(S.Z)CO.,LTD AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		
			X.XXX±.004(0.10)    .XXX'±0.5'					

1 2 3 4 5 6 7 8